FIBOCOM H330S Mini PCIe adopts one of the most advanced Intel platforms in the industry and supports the common frequencies of 3G. It has a built-in TCP/IP&UDP/IP protocol stack. Optimized for low power consumption, H330S Mini PCIe is ideal for today’s security, gate way, router and industrial IoT applications.

Available For

- Global Market
# H330S Mini PCIe HSPA+ Module Technical Specifications

## Product Features
- WCDMA: Band 1,2,5,8 or Band 1,8
- GSM/GPRS/EDGE: 850/900/1800/1900MHz or 900/1800MHz
- Mini-PCIe: 30.0 x 50.95 x 3.45mm
- Operating Temperature: -30 ~ +85℃
- Storage Temperature: -40 ~ +85℃
- Operating Voltage: DC 3.0 ~ 3.6V, Typical 3.3V
- TX Power
  - UMTS/HSPA+ Class 3 (0.25W)
  - GSM 850/900 MHz Class 4 (2W)
  - GSM 1800/1900 MHz Class 1 (1W)
  - EDGE 850/900 MHz Class E2 (0.5W)
  - EDGE 1800/1900 MHz Class E2 (0.4W)
- AT Command Set: FIBOCOM proprietary AT commands/GSM 07.05/GSM 07.07

## Data
- UMTS/HSDPA/HSUPA 3GPP release 7
  - HSDPA 5.76Mbps (Cat 6)
  - HSUPA 21Mbps (Cat 14)/7.2Mbps (Cat 8)
- GSM 3GPP release 7
  - EDGE (E-GPRS) Multi-slot class 33 (296kbps DL, 236.8kbps UL)
  - GPRS Multi-slot class 33 (107kbps DL, 85.6kbps UL)
- MUX:
  - Basic Mode
- SMS:
  - MO/MT Text and PDU modes
  - Cell broadcast
  - Embedded TCP/IP and UDP/IP protocol stack

## Interfaces
- SIM Card: 1.8V/3.0V
- 1 x USB 2.0
- Multiple Profiles over USB
- 2 x UART
- PCM Voice

## Approvals
- CCC/SRRC/NAL/RoHS/CE /GCF/PTCRB/TELEC/RCM/ANATEL

## Drivers
- Win CE
- Linux 2.6.18 above
- Android 4.2 above